



Thermal Pad High Performance Gap Filler



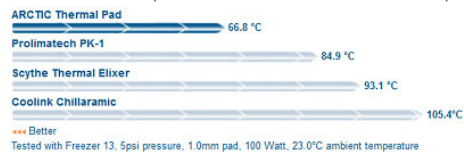
Gapless Heat Dissipation

ARCTIC's Thermal Pad bridges problem-free even large spaces

After multiple awards with its thermal pastes, ARCTIC is now offering thermal pads as well. As perfect gap filler the Thermal Pad provides an optimal heat transfer and bridges even large height differences and uneven surfaces.

Often it is troublesome to cool diverse components like memory chips, CPUs, MCUs, DSPs and other ICs densely packed. Different heights prevent a proper contact to the heatsink and thus make it useless. The thermal pad is perfect to close even large spaces completely. Due to its low hardness this silicon pad adapts ideally to uneven surfaces, also at low pressure and thus ensures the best possible heat dissipation.

In the comparison test the Thermal Pad with its special filler and a high thermal conductivity can demonstrate its performance and leaves the competitors behind.



That's maximum performance at a minimum effort, since the installation of the Thermal Pad is child's play – perfect for beginners. It does not contain any metallic particles, is electrically isolating and not capacitive. The handling is safe as contact with any electrical trace would not result in damage of any sort.

QUICK FACTS Thermal Pad High Performance Gap Filler

- Electrically non-conductive
- Thermal conductivity 6.0 W/mK
- Safe and easy handling
- Measures:
 - 50 x 50 x 0,5 mm | x 1 mm | x 1.5 mm
 - 145 x 145 x 0,5 mm | x 1 mm | x 1.5 mm

About ARCTIC

As an international company ARCTIC is one of the leading manufacturers of computer cooling and has a profound know-how in the field of consumer electronics. With headquarters in Switzerland and offices in Hong Kong, Germany and the U.S., we sell our products in over 45 countries around the world.